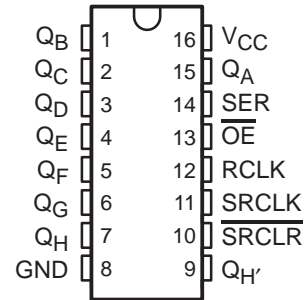


SN54HC595, SN74HC595 8-BIT SHIFT REGISTERS WITH 3-STATE OUTPUT REGISTERS

SCLS041G – DECEMBER 1982 – REVISED FEBRUARY 2004

- 8-Bit Serial-In, Parallel-Out Shift
- Wide Operating Voltage Range of 2 V to 6 V
- High-Current 3-State Outputs Can Drive Up To 15 LSTTL Loads
- Low Power Consumption, 80- μ A Max I_{CC}
- Typical $t_{pd} = 13$ ns
- ± 6 -mA Output Drive at 5 V
- Low Input Current of 1 μ A Max
- Shift Register Has Direct Clear

SN54HC595 . . . J OR W PACKAGE
SN74HC595 . . . D, DB, DW, N, OR NS PACKAGE
(TOP VIEW)

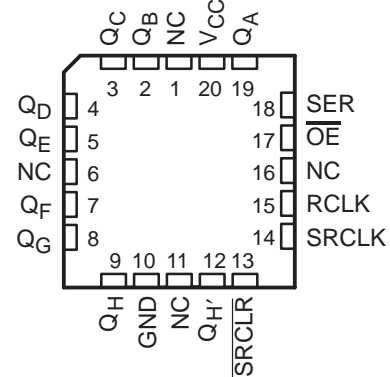


description/ordering information

The 'HC595 devices contain an 8-bit serial-in, parallel-out shift register that feeds an 8-bit D-type storage register. The storage register has parallel 3-state outputs. Separate clocks are provided for both the shift and storage register. The shift register has a direct overriding clear (\overline{SRCLR}) input, serial (SER) input, and serial outputs for cascading. When the output-enable (\overline{OE}) input is high, the outputs are in the high-impedance state.

Both the shift register clock (SRCLK) and storage register clock (RCLK) are positive-edge triggered. If both clocks are connected together, the shift register always is one clock pulse ahead of the storage register.

SN54HC595 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

ORDERING INFORMATION

| TA | PACKAGE† | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-----------|--------------|-----------------------|------------------|
| -40°C to 85°C | PDIP – N | Tube of 25 | SN74HC595N | SN74HC595N |
| | SOIC – D | Tube of 40 | SN74HC595D | HC595 |
| | | Reel of 2500 | SN74HC595DR | |
| | | Reel of 250 | SN74HC595DT | |
| | SOIC – DW | Tube of 40 | SN74HC595DW | HC595 |
| | | Reel of 2000 | SN74HC595DWR | |
| -55°C to 125°C | SOP – NS | Reel of 2000 | SN74HC595NSR | HC595 |
| | SSOP – DB | Reel of 2000 | SN74HC595DBR | HC595 |
| | CDIP – J | Tube of 25 | SNJ54HC595J | SNJ54HC595J |
| | CFP – W | Tube of 150 | SNJ54HC595W | SNJ54HC595W |
| | LCCC – FK | Tube of 55 | SNJ54HC595FK | SNJ54HC595FK |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

SN54HC595, SN74HC595
8-BIT SHIFT REGISTERS
WITH 3-STATE OUTPUT REGISTERS

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FUNCTION TABLE

| INPUTS | | | | | FUNCTION |
|--------|-------|-------|------|----|--|
| SER | SRCLK | SRCLR | RCLK | OE | |
| X | X | X | X | H | Outputs Q _A –Q _H are disabled. |
| X | X | X | X | L | Outputs Q _A –Q _H are enabled. |
| X | X | L | X | X | Shift register is cleared. |
| L | ↑ | H | X | X | First stage of the shift register goes low. Other stages store the data of previous stage, respectively. |
| H | ↑ | H | X | X | First stage of the shift register goes high. Other stages store the data of previous stage, respectively. |
| X | X | X | ↑ | X | Shift-register data is stored in the storage register. |

SN54HC595, SN74HC595
8-BIT SHIFT REGISTERS
WITH 3-STATE OUTPUT REGISTERS
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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|---|----------------|
| Supply voltage range, V_{CC} | –0.5 V to 7 V |
| Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1) | ±20 mA |
| Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1) | ±20 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | ±35 mA |
| Continuous current through V_{CC} or GND | ±70 mA |
| Package thermal impedance, θ_{JA} (see Note 2): D package | 73°C/W |
| DB package | 82°C/W |
| DW package | 57°C/W |
| N package | 67°C/W |
| NS package | 64°C/W |
| Storage temperature range, T_{stg} | –65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

| | | SN54HC595 | | | SN74HC595 | | | UNIT |
|-----------------------|---------------------------------|------------------|-----|----------|------------------|-----|----------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| V_{CC} | Supply voltage | 2 | 5 | 6 | 2 | 5 | 6 | V |
| V_{IH} | High-level input voltage | $V_{CC} = 2$ V | | 1.5 | $V_{CC} = 2$ V | | 1.5 | V |
| | | $V_{CC} = 4.5$ V | | 3.15 | $V_{CC} = 4.5$ V | | 3.15 | |
| | | $V_{CC} = 6$ V | | 4.2 | $V_{CC} = 6$ V | | 4.2 | |
| V_{IL} | Low-level input voltage | $V_{CC} = 2$ V | | | $V_{CC} = 2$ V | | 0.5 | V |
| | | $V_{CC} = 4.5$ V | | | $V_{CC} = 4.5$ V | | 1.35 | |
| | | $V_{CC} = 6$ V | | | $V_{CC} = 6$ V | | 1.8 | |
| V_I | Input voltage | 0 | | V_{CC} | 0 | | V_{CC} | V |
| V_O | Output voltage | 0 | | V_{CC} | 0 | | V_{CC} | V |
| $\Delta t/\Delta v$ ‡ | Input transition rise/fall time | $V_{CC} = 2$ V | | | $V_{CC} = 2$ V | | 1000 | ns |
| | | $V_{CC} = 4.5$ V | | | $V_{CC} = 4.5$ V | | 500 | |
| | | $V_{CC} = 6$ V | | | $V_{CC} = 6$ V | | 400 | |
| T_A | Operating free-air temperature | –55 | | 125 | –40 | | 85 | °C |

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

‡ If this device is used in the threshold region (from $V_{IL,max} = 0.5$ V to $V_{IH,min} = 1.5$ V), there is a potential to go into the wrong state from induced grounding, causing double clocking. Operating with the inputs at $t_f = 1000$ ns and $V_{CC} = 2$ V does not damage the device; however, functionally, the CLK inputs are not ensured while in the shift, count, or toggle operating modes.



SN54HC595, SN74HC595
8-BIT SHIFT REGISTERS
WITH 3-STATE OUTPUT REGISTERS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | | V _{CC} | T _A = 25°C | | | SN54HC595 | | SN74HC595 | | UNIT |
|-----------------|---|--------------------------|--|-----------------------|-------|------|-----------|-----|-----------|-----|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| V _{OH} | V _I = V _{IH} or V _{IL} | I _{OH} = -20 μA | 2 V | 1.9 | 1.998 | | 1.9 | | 1.9 | V | |
| | | | 4.5 V | 4.4 | 4.499 | | 4.4 | | 4.4 | | |
| | | | 6 V | 5.9 | 5.999 | | 5.9 | | 5.9 | | |
| | | 4.5 V | Q _{H'} , I _{OH} = -4 mA | 3.98 | 4.3 | | 3.7 | | 3.84 | | |
| | | | Q _A -Q _H , I _{OH} = -6 mA | 3.98 | 4.3 | | 3.7 | | 3.84 | | |
| | | 6 V | Q _{H'} , I _{OH} = -5.2 mA | 5.48 | 5.8 | | 5.2 | | 5.34 | | |
| | | | Q _A -Q _H , I _{OH} = -7.8 mA | 5.48 | 5.8 | | 5.2 | | 5.34 | | |
| V _{OL} | V _I = V _{IH} or V _{IL} | I _{OL} = 20 μA | 2 V | | 0.002 | 0.1 | | 0.1 | | V | |
| | | | 4.5 V | | 0.001 | 0.1 | | 0.1 | | | |
| | | | 6 V | | 0.001 | 0.1 | | 0.1 | | | |
| | | 4.5 V | Q _{H'} , I _{OL} = 4 mA | | 0.17 | 0.26 | | 0.4 | | | 0.33 |
| | | | Q _A -Q _H , I _{OL} = 6 mA | | 0.17 | 0.26 | | 0.4 | | | 0.33 |
| | | 6 V | Q _{H'} , I _{OL} = 5.2 mA | | 0.15 | 0.26 | | 0.4 | | | 0.33 |
| | | | Q _A -Q _H , I _{OL} = 7.8 mA | | 0.15 | 0.26 | | 0.4 | | | 0.33 |
| I _I | V _I = V _{CC} or 0 | 6 V | | ±0.1 | ±100 | | ±1000 | | ±1000 | nA | |
| I _{OZ} | V _O = V _{CC} or 0, Q _A -Q _H | 6 V | | ±0.01 | ±0.5 | | ±10 | | ±5 | μA | |
| I _{CC} | V _I = V _{CC} or 0, I _O = 0 | 6 V | | | 8 | | 160 | | 80 | μA | |
| C _i | | 2 V to 6 V | | | 3 | 10 | | 10 | | 10 | pF |



SN54HC595, SN74HC595
8-BIT SHIFT REGISTERS
WITH 3-STATE OUTPUT REGISTERS
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timing requirements over recommended operating free-air temperature range (unless otherwise noted)

| | | V _{CC} | T _A = 25°C | | SN54HC595 | | SN74HC595 | | UNIT |
|--------------------|---|-----------------|-----------------------|-----|-----------|-----|-----------|-----|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | |
| f _{clock} | Clock frequency | 2 V | 6 | | 4.2 | | 5 | | MHz |
| | | 4.5 V | 31 | | 21 | | 25 | | |
| | | 6 V | 36 | | 25 | | 29 | | |
| t _w | SRCLK or RCLK high or low | 2 V | 80 | | 120 | | 100 | | ns |
| | | 4.5 V | 16 | | 24 | | 20 | | |
| | | 6 V | 14 | | 20 | | 17 | | |
| | $\overline{\text{SRCLR}}$ low | 2 V | 80 | | 120 | | 100 | | |
| | | 4.5 V | 16 | | 24 | | 20 | | |
| | | 6 V | 14 | | 20 | | 17 | | |
| t _{su} | SER before SRCLK↑ | 2 V | 100 | | 150 | | 125 | | ns |
| | | 4.5 V | 20 | | 30 | | 25 | | |
| | | 6 V | 17 | | 25 | | 21 | | |
| | SRCLK↑ before RCLK↑† | 2 V | 75 | | 113 | | 94 | | |
| | | 4.5 V | 15 | | 23 | | 19 | | |
| | | 6 V | 13 | | 19 | | 16 | | |
| | $\overline{\text{SRCLR}}$ low before RCLK↑ | 2 V | 50 | | 75 | | 65 | | |
| | | 4.5 V | 10 | | 15 | | 13 | | |
| | | 6 V | 9 | | 13 | | 11 | | |
| | $\overline{\text{SRCLR}}$ high (inactive) before SRCLK↑ | 2 V | 50 | | 75 | | 60 | | |
| | | 4.5 V | 10 | | 15 | | 12 | | |
| | | 6 V | 9 | | 13 | | 11 | | |
| t _h | Hold time, SER after SRCLK↑ | 2 V | 0 | | 0 | | 0 | | ns |
| | | 4.5 V | 0 | | 0 | | 0 | | |
| | | 6 V | 0 | | 0 | | 0 | | |

† This setup time allows the storage register to receive stable data from the shift register. The clocks can be tied together, in which case the shift register is one clock pulse ahead of the storage register.

SN54HC595, SN74HC595
8-BIT SHIFT REGISTERS
WITH 3-STATE OUTPUT REGISTERS

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switching characteristics over recommended operating free-air temperature range, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CC} | T _A = 25°C | | | SN54HC595 | | SN74HC595 | | UNIT |
|------------------|---------------------------|--------------------------------|-----------------|-----------------------|-----|-----|-----------|-----|-----------|-----|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| f _{max} | | | 2 V | 6 | 26 | | 4.2 | | 5 | MHz | |
| | | | 4.5 V | 31 | 38 | | 21 | | 25 | | |
| | | | 6 V | 36 | 42 | | 25 | | 29 | | |
| t _{pd} | SRCLK | Q _{H'} | 2 V | | 50 | 160 | | 240 | | 200 | ns |
| | | | 4.5 V | | 17 | 32 | | 48 | | 40 | |
| | | | 6 V | | 14 | 27 | | 41 | | 34 | |
| | RCLK | Q _A -Q _H | 2 V | | 50 | 150 | | 225 | | 187 | |
| | | | 4.5 V | | 17 | 30 | | 45 | | 37 | |
| | | | 6 V | | 14 | 26 | | 38 | | 32 | |
| t _{PHL} | $\overline{\text{SRCLR}}$ | Q _{H'} | 2 V | | 51 | 175 | | 261 | | 219 | ns |
| | | | 4.5 V | | 18 | 35 | | 52 | | 44 | |
| | | | 6 V | | 15 | 30 | | 44 | | 37 | |
| t _{en} | $\overline{\text{OE}}$ | Q _A -Q _H | 2 V | | 40 | 150 | | 225 | | 187 | ns |
| | | | 4.5 V | | 15 | 30 | | 45 | | 37 | |
| | | | 6 V | | 13 | 26 | | 38 | | 32 | |
| t _{dis} | $\overline{\text{OE}}$ | Q _A -Q _H | 2 V | | 42 | 200 | | 300 | | 250 | ns |
| | | | 4.5 V | | 23 | 40 | | 60 | | 50 | |
| | | | 6 V | | 20 | 34 | | 51 | | 43 | |
| t _t | | Q _A -Q _H | 2 V | | 28 | 60 | | 90 | | 75 | ns |
| | | | 4.5 V | | 8 | 12 | | 18 | | 15 | |
| | | | 6 V | | 6 | 10 | | 15 | | 13 | |
| | | Q _{H'} | 2 V | | 28 | 75 | | 110 | | 95 | |
| | | | 4.5 V | | 8 | 15 | | 22 | | 19 | |
| | | | 6 V | | 6 | 13 | | 19 | | 16 | |

switching characteristics over recommended operating free-air temperature range, $C_L = 150$ pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CC} | T _A = 25°C | | | SN54HC595 | | SN74HC595 | | UNIT |
|-----------------|------------------------|--------------------------------|-----------------|-----------------------|-----|-----|-----------|-----|-----------|-----|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| t _{pd} | RCLK | Q _A -Q _H | 2 V | | 60 | 200 | | 300 | | 250 | ns |
| | | | 4.5 V | | 22 | 40 | | 60 | | 50 | |
| | | | 6 V | | 19 | 34 | | 51 | | 43 | |
| t _{en} | $\overline{\text{OE}}$ | Q _A -Q _H | 2 V | | 70 | 200 | | 298 | | 250 | ns |
| | | | 4.5 V | | 23 | 40 | | 60 | | 50 | |
| | | | 6 V | | 19 | 34 | | 51 | | 43 | |
| t _t | | Q _A -Q _H | 2 V | | 45 | 210 | | 315 | | 265 | ns |
| | | | 4.5 V | | 17 | 42 | | 63 | | 53 | |
| | | | 6 V | | 13 | 36 | | 53 | | 45 | |

operating characteristics, T_A = 25°C

| PARAMETER | TEST CONDITIONS | TYP | UNIT |
|---|-----------------|-----|------|
| C _{pd} Power dissipation capacitance | No load | 400 | pF |



PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|--|
| 5962-86816012A | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| 5962-8681601EA | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| 5962-8681601VEA | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| 5962-8681601VFA | ACTIVE | CFP | W | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN54HC595J | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN74HC595D | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1YEAR |
| SN74HC595DBR | ACTIVE | SSOP | DB | 16 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |
| SN74HC595DBRE4 | ACTIVE | SSOP | DB | 16 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |
| SN74HC595DE4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1YEAR |
| SN74HC595DR | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1YEAR |
| SN74HC595DRE4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1YEAR |
| SN74HC595DT | ACTIVE | SOIC | D | 16 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1YEAR |
| SN74HC595DTE4 | ACTIVE | SOIC | D | 16 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1YEAR |
| SN74HC595DW | ACTIVE | SOIC | DW | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC595DWE4 | ACTIVE | SOIC | DW | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC595DWR | ACTIVE | SOIC | DW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC595DWRE4 | ACTIVE | SOIC | DW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC595N | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74HC595NSR | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC595NSRE4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC595PW | ACTIVE | TSSOP | PW | 16 | 90 | Pb-Free (RoHS) | CU NIPDAU | Level-1-250C-UNLIM |
| SN74HC595PWE4 | ACTIVE | TSSOP | PW | 16 | 90 | Pb-Free (RoHS) | CU NIPDAU | Level-1-250C-UNLIM |
| SN74HC595PWR | ACTIVE | TSSOP | PW | 16 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-1-250C-UNLIM |
| SN74HC595PWRE4 | ACTIVE | TSSOP | PW | 16 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-1-250C-UNLIM |
| SNJ54HC595FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54HC595J | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54HC595W | OBSOLETE | | | 16 | | TBD | Call TI | Call TI |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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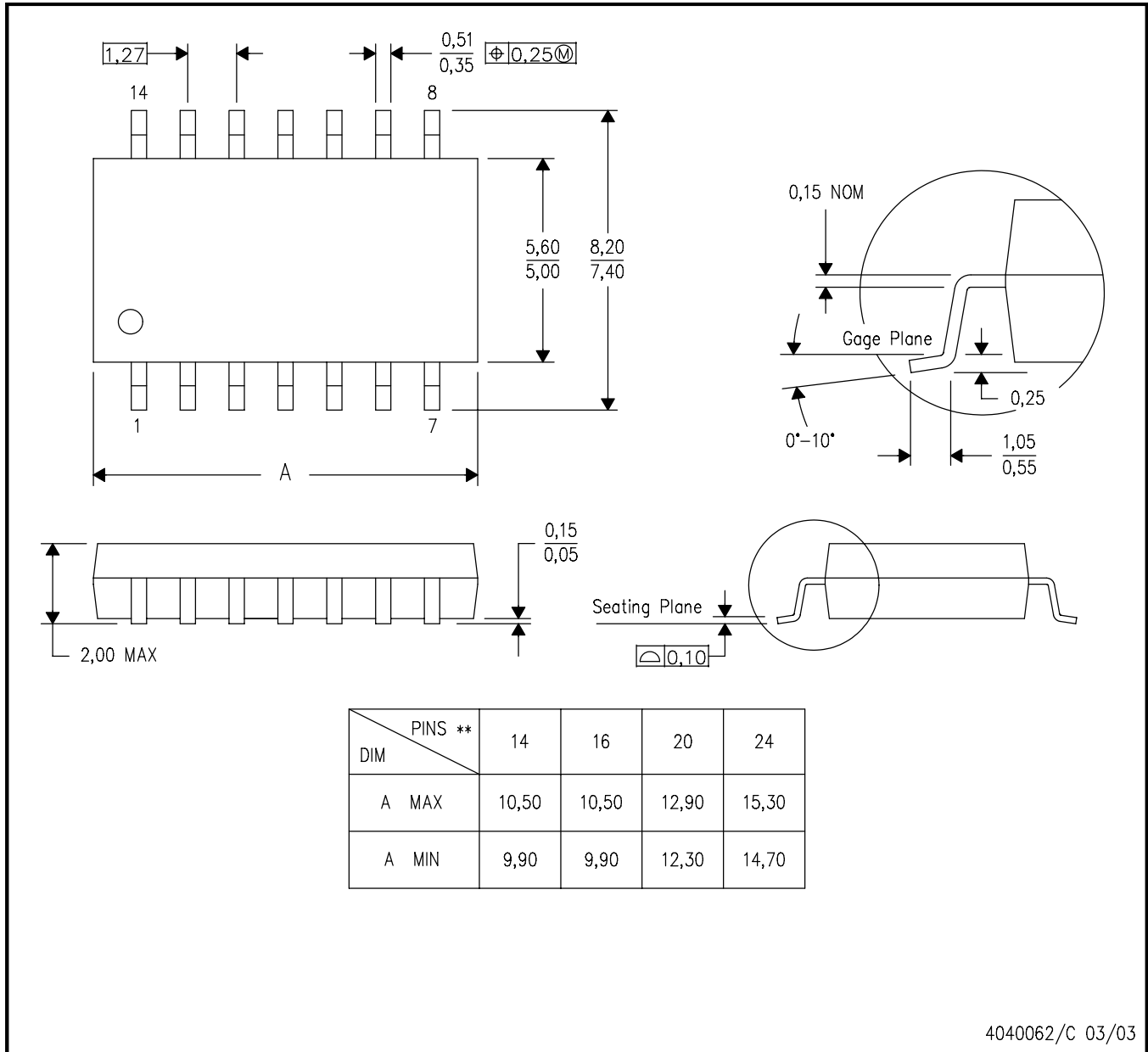
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MECHANICAL DATA

NS (R-PDSO-G)**

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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